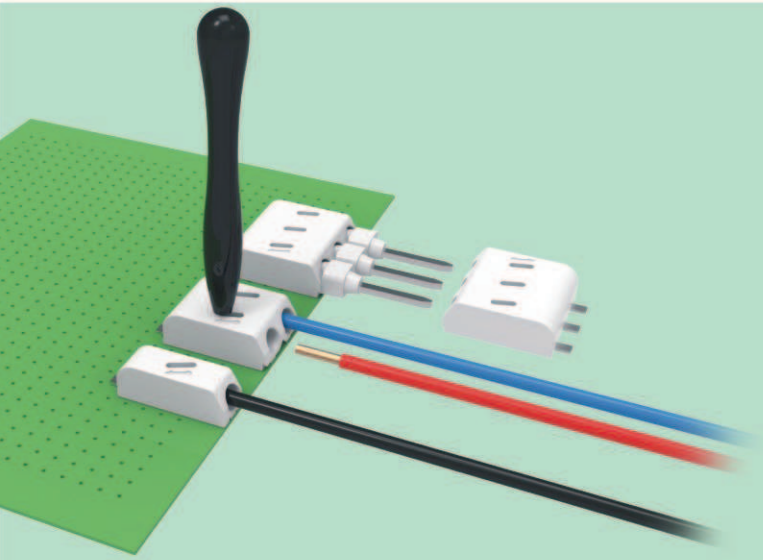
DEGSON®

寧波高正電子有限公司
DEGSON ELECTRONICS CO.,LTD.



DG2002

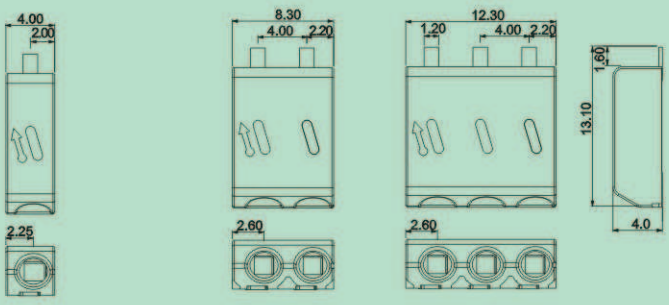
APPROVAL: c UL us CE

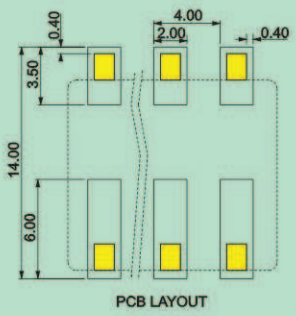
- 插入式弹簧结构设计，接线更快速。
- 耐高温材料，可采用SMT回流焊接。
- 紧凑型结构设计，高度仅4.0mm。
- 0.2mm²-0.75mm²线径可供选择。
- 专利技术产品 专利号：201410249898.6
- Push-in design ,faster connection.
- Heat-resistance material,suitable for SMT soldering.
- Compact the height is as low as 4.0mm.
- Wire range 0.2mm2-0.75mm2.
- Patented product patent No.:201410249898.6

DG2002-4.0-01P

DG2002-4.0-02P

DG2002-4.0-03P





PCB LAYOUT

技术参数 Technical Data

型号 Model	线径 Wire range	线数 Poles	IEC技术参数（datasheet）		UL技术参数（datasheet）	
			电压(V) Rated voltage	电流(A) Rated current	电压(V) Rated voltage	电流(A) Rated current
DG2002-4.0	0.2-0.75mm2 /24-18AWG/SOL	01-03P	160V	9A	300V	9A

产品附件 Application

型号/Model	线数/Poles	用途/Appliction field	图片/Figure
DG027-4.0	1P/2P/3P	导通件/Bridge accessories	
DG028	1P	取线工具/Tool	

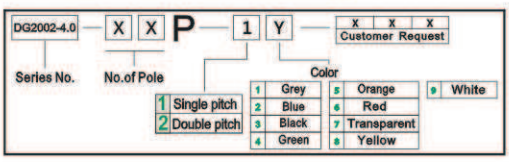
产品包装方式 Packing

Product model	Pcs./Pkt.
DG2002-4.0-01P	1500
DG2002-4.0-02P	1000
DG2002-4.0-03P	750

应用行业 Application

LED照明行业
LED lighting

产品订货 How to order



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